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AO3442

100V N-Channel MOSFET

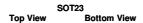
General Description

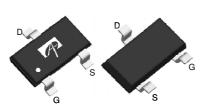
The AO3442 combines advanced trench MOSFET technology with a low resistance package to provide extremely low $R_{\rm DS(ON)}$. This device is ideal for boost converters and synchronous rectifiers for consumer, telecom, industrial power supplies and LED backlighting.

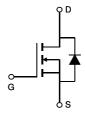
Product Summary

 $\begin{array}{ll} V_{DS} & 100V \\ I_{D} \; (at \; V_{GS} \! = \! 10V) & 1A \\ R_{DS(ON)} \; (at \; V_{GS} \! = \! 10V) & < 630 m\Omega \\ R_{DS(ON)} \; (at \; V_{GS} \! = \! 4.5V) & < 720 m\Omega \end{array}$









Absolute Maximum Ratings T_A=25℃ unless otherwise noted

Parameter		Symbol	Maximum	Units		
Drain-Source Voltage		V_{DS}	100	V		
Gate-Source Voltage		V _{GS}	±20	V		
Continuous Drain	T _A =25℃		1			
Current	T _A =70℃	'D	0.8	A		
Pulsed Drain Current ^C		I _{DM}	4			
	T _A =25℃	P _D	1.4	W		
Power Dissipation ^B	rer Dissipation ^B T _A =70℃		0.9	VV		
Junction and Storage Temperature Range		T _J , T _{STG}	-55 to 150	C		

Thermal Characteristics								
Parameter	Symbol	Тур	Max	Units				
Maximum Junction-to-Ambient A	t ≤ 10s	D	70	90				
Maximum Junction-to-Ambient AD	Steady-State	$R_{\theta JA}$	100	125				
Maximum Junction-to-Lead Steady-Stat		$R_{\theta JL}$	63	80	℃/W			



Electrical Characteristics (T_J=25℃ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Units				
STATIC PARAMETERS										
BV_{DSS}	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$		100			V			
I _{DSS}	Zero Gate Voltage Drain Current	V_{DS} =100V, V_{GS} =0V				1	^			
			T _J =55℃			5	μΑ			
I_{GSS}	Gate-Body leakage current	V_{DS} =0V, V_{GS} =±20V	V _{DS} =0V, V _{GS} =±20V			±100	nA			
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$		1.7	2.3	2.9	V			
$I_{D(ON)}$	On state drain current	$V_{GS}=10V, V_{DS}=5V$		4			Α			
R _{DS(ON)}	Static Drain-Source On-Resistance	$V_{GS}=10V$, $I_{D}=1A$			514	630	mΩ			
			T _J =125℃		983	1200	11152			
		V_{GS} =4.5V, I_{D} =0.8A			554	720	mΩ			
g _{FS}	Forward Transconductance	$V_{DS}=5V$, $I_{D}=1A$			2.8		S			
V_{SD}	Diode Forward Voltage	I _S =1A,V _{GS} =0V			0.9	1.2	V			
Is	Maximum Body-Diode Continuous Cur	rent ^G			1	Α				
DYNAMIC	PARAMETERS									
C _{iss}	Input Capacitance				100		pF			
C _{oss}	Output Capacitance	V_{GS} =0V, V_{DS} =50V, f=1MHz			13		pF			
C_{rss}	Reverse Transfer Capacitance				5		pF			
R_g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz		2.5	5	7.5	Ω			
SWITCHII	NG PARAMETERS									
Q _g (10V)	Total Gate Charge	V _{GS} =10V, V _{DS} =50V, I _D =1A			2.8	6	nC			
Q _g (4.5V)	Total Gate Charge				1.5	3	nC			
Q_{gs}	Gate Source Charge				0.4		nC			
Q_{gd}	Gate Drain Charge				0.8		nC			
t _{D(on)}	Turn-On DelayTime				5		ns			
t _r	Turn-On Rise Time	V_{GS} =10V, V_{DS} =50V, R_L =50 Ω , R_{GEN} =3 Ω			4		ns			
t _{D(off)}	Turn-Off DelayTime				12		ns			
t _f	Turn-Off Fall Time				5		ns			
t _{rr}	Body Diode Reverse Recovery Time	I _F =5.6A, dI/dt=100A/μs			52		ns			
Q_{rr}	Body Diode Reverse Recovery Charge	I _F =5.6A, dI/dt=100A/	us		60		nC			

A. The value of $R_{\theta JA}$ is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_A =25° C. The value in any given application depends on the user's specific board design. B. The power dissipation P_D is based on $T_{J(MAX)}$ =150° C, using \leqslant 10s junction-to-ambient thermal resistance.

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C. Repetitive rating, pulse width limited by junction temperature T_{J(MAX)}=150° C. Ratings are based on low frequency and duty cycles to keep initialT_{.1}=25° C.

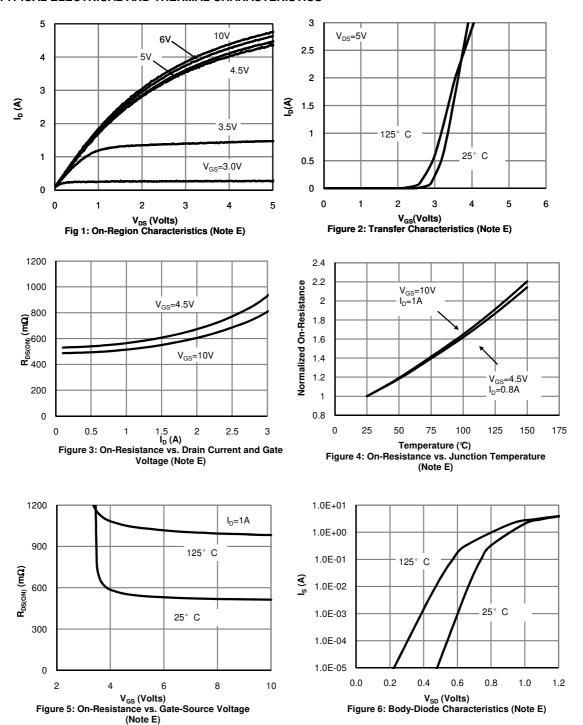
D. The $R_{\theta JA}$ is the sum of the thermal impedance from junction to lead $R_{\theta JL}$ and lead to ambient.

E. The static characteristics in Figures 1 to 6 are obtained using <300μs pulses, duty cycle 0.5% max.

F. These curves are based on the junction-to-ambient thermal impedance which is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, assuming a maximum junction temperature of $T_{J_j(MAX)}=150^{\circ}$ C. The SOA curve provides a single pulse rating.

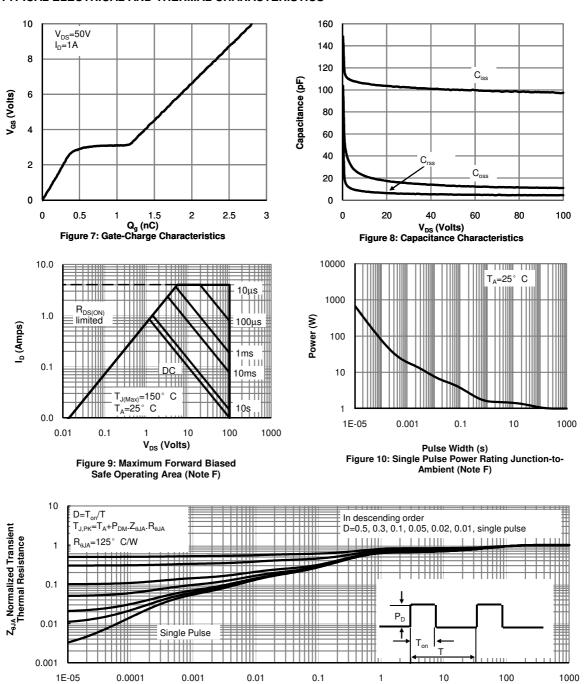


TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS





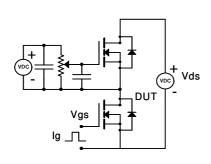
TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

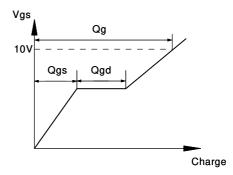


Pulse Width (s)
Figure 11: Normalized Maximum Transient Thermal Impedance (Note F)

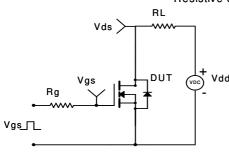


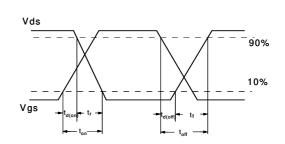
Gate Charge Test Circuit & Waveform





Resistive Switching Test Circuit & Waveforms





Diode Recovery Test Circuit & Waveforms

